

# China Die Bonding Equipment Market Research Report 2018

<https://marketpublishers.com/r/C9EE7664590QEN.html>

Date: February 2018

Pages: 108

Price: US\$ 3,400.00 (Single User License)

ID: C9EE7664590QEN

## Abstracts

The global Die Bonding Equipment market is valued at XX million USD in 2016 and is expected to reach XX million USD by the end of 2022, growing at a CAGR of XX% between 2016 and 2022.

China plays an important role in global market, with market size of xx million USD in 2016 and will be xx million USD in 2022, with a CAGR of xx%.

This report studies the Die Bonding Equipment development status and future trend in China, focuses on top players in China, also splits Die Bonding Equipment by type and by applications, to fully and deeply research and reveal the market general situation and future forecast.

The major players in China market include

Besi

ASM Pacific Technology (ASMPT)

Kulicke & Soffa

Palomar Technologies

Shinkawa

DIAS Automation

Toray Engineering

Panasonic

FASFORD TECHNOLOGY

West-Bond

Hybond

Geographically, this report splits the China market into six regions,

South China

East China

Southwest China

Northeast China

North China

Central China

Northwest China

On the basis of product, this report displays the sales volume (K Units), revenue (Million USD), product price (USD/Unit), market share and growth rate of each type, primarily split into

Fully Automatic

Semi-Automatic

Manual

On the basis of the end users/application, this report covers

Integrated Device Manufacturers (IDMs)

Outsourced Semiconductor Assembly and Test (OSAT)

If you have any special requirements, please let us know and we will offer you the report as you want.

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